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1 Package size and epoxy mass effects on package hermeticity requirements

Bjorndahl, W.D.;

Aerospace Conference, 1997. Proceedings., IEEE, Volume: 4, 1-8 Feb. 1997
Pages:277 - 283 vol.4

[\[Abstract\]](#) [\[PDF Full-Text \(504 KB\)\]](#) **IEEE CNF**

2 An ac impedance in situ methodology for assessing high reliability performance of plastic encapsulated microelectronics in harsh environments

Lumsden, J.; Kuo, J.; Pollock, G.;

Electronic Components and Technology Conference, 2002. Proceedings. 52nd, 28-31 May 2002
Pages:219 - 224

[\[Abstract\]](#) [\[PDF Full-Text \(677 KB\)\]](#) **IEEE CNF**

3 Critical issues in thin layer acoustic image interpretation and metrology for microelectronics

Canumalla, S.;

Electronic Components and Technology Conference, 2002. Proceedings. 52nd, 28-31 May 2002
Pages:205 - 218

[\[Abstract\]](#) [\[PDF Full-Text \(1297 KB\)\]](#) **IEEE CNF**

4 The use of time domain spectroscopy as a diagnostic tool for rotating machine windings

David, E.; Lamarre, L.; Nguyen, D.N.;

Electrical Insulation, 2002. Conference Record of the 2002 IEEE International Symposium on, 7-10 April 2002
Pages:506 - 510